

ABSTRACT OF THE DISCLOSURE

A pin connector has an outer contact bent outwardly from at least a portion of a side wall of a metallic slender sleeve and an inner contact bent inwardly from at least a portion of a side wall of the metallic slender sleeve. The outer contact and the inner contact are resilient radially of the metallic slender sleeve. An electronic component packaging board comprises a board having a through hole defined therein in alignment with an external lead of an electronic component, the pin connector being inserted and held in the through hole. The electronic component packaging board also has another board disposed on the reverse side of the board and having a through hole defined therein. An end portion of the pin connector projects from the through hole in the board and is soldered to the other board in the through hole thereof. A positioning structure such as a pin positions the pin connector inserted in the through hole in the board with respect to the through hole in the other board.

